

9.5 Ω R_{ON} ±15 V/+12 V/±5 V *i*CMOS Serially-Controlled Octal SPST Switches

Data Sheet

FEATURES

SPI interface Supports daisy-chain mode 9.5 Ω on resistance @ 25°C 1.6 Ω on-resistance flatness Fully specified at ±15 V, +12 V, ±5 V 3 V logic-compatible inputs Rail-to-rail operation 24-lead TSSOP and 24-lead 4 mm × 4 mm LFCSP

APPLICATIONS

Automatic test equipment Data acquisition systems Battery-powered systems Sample-and-hold systems Audio signal routing Video signal routing Communication systems

GENERAL DESCRIPTION

The ADG1414 is a monolithic complementary metal-oxide semiconductor (CMOS) device containing eight independently selectable switches designed on an industrial CMOS (*i*CMOS*) process. *i*CMOS is a modular manufacturing process combining high voltage CMOS and bipolar technologies. *i*CMOS components can tolerate high supply voltages while providing increased performance, dramatically lower power consumption, and reduce the package size.

The ADG1414 is a set of octal SPST (single-pole, single-throw) switches controlled via a 3-wire serial interface. On resistance is closely matched between switches and is very flat over the full signal range. Each switch conducts equally well in both directions and the input signal range extends to the supplies.

ADG1414

FUNCTIONAL BLOCK DIAGRAM



Data is written to these devices in the form of eight bits; each bit corresponds to one channel.

The ADG1414 utilizes a versatile 3-wire serial interface that operates at clock rates of up to 50 MHz and is compatible with standard SPI, QSPI[™], MICROWIRE[™], and DSP interface standards. The output of the shift register, SDO, enables a number of these parts to be daisy chained.

On power-up, all switches are in the off condition, and the internal registers contain all zeros.

PRODUCT HIGHLIGHTS

- 1. 50 MHz serial interface.
- 2. 9.5 Ω on resistance.
- 3. 1.6 Ω on-resistance flatness.
- 4. 24-lead TSSOP and 4 mm \times 4 mm LFCSP packages.

Document Feedback

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REVISION HISTORY

1/13—Rev. 0 to Rev. A Changes to Pin RESET/VL Description 11 Changes to Power-On Reset Section 19 Updated Outline Dimensions 20 10/09—Revision 0: Initial Version

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SPECIFICATIONS

±15 V DUAL SUPPLY

 V_{DD} = 15 V \pm 10%, V_{SS} = –15 V \pm 10%, V_{L} = 2.7 V to 5.5 V, GND = 0 V, unless otherwise noted.

Table 1.

Parameter	+25°C	–40°C to +85°C	–40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			Vss to VDD	V	
On Resistance (R _{ON})	9.5			Ωtyp	V_{DD} = +13.5 V, V_{SS} = -13.5 V, V_S = ±10 V, I_S = -10 mA; see Figure 23
	11.5	14	16	Ωmax	_
On-Resistance Match Between Channels (ΔR_{ON})	0.55			Ωtyp	V_{DD} = +13.5 V, V_{SS} = -13.5 V, V_S = ±10 V, I_S = -10 mA
	1	1.5	1.7	Ωmax	
On-Resistance Flatness (R _{FLAT(ON)})	1.6			Ωtyp	V_{DD} = +13.5 V, V_{SS} = -13.5 V, V_S = ±10 V, I_S =
	1.9	2.15	2.3	Ωmax	–10 mA
LEAKAGE CURRENTS					$V_{DD} = +16.5 \text{ V}, \text{V}_{SS} = -16.5 \text{ V}$
Source Off Leakage, Is (Off)	±0.05			nA typ	$V_s = \pm 10 V$, $V_D = \mp 10 V$; see Figure 24
	±0.15	±1	±2	nA max	
Drain Off Leakage, I _D (Off)	±0.05			nA typ	$V_s = \pm 10 \text{ V}, V_D = \mp 10 \text{ V};$ see Figure 24
-	±0.15	±1	±2	nA max	
Channel On Leakage, I _D , I _S (On)	±0.1			nA typ	$V_s = V_D = \pm 10 V$; see Figure 25
e	±0.3	±2	±4	nA max	······································
DIGITAL INPUTS	_0.5	-		The contract	
Input High Voltage, VINH			2.0	V min	
Input Low Voltage, V _{INL}			0.8	V max	
Input Current	±0.001		0.0	μA typ	$V_{IN} = V_{GND} \text{ or } V_{I}$
input current	10.001		±0.1	μA max	
Digital Input Capacitance, C _{IN}	4		_0.1	pF typ	
LOGIC OUTPUTS (SDO)				p: 0p	
Output Low Voltage, V_{OL}^1			0.4	V max	$I_{SINK} = 3 \text{ mA}$
output Low Voltage, Vol			0.6	V max	$I_{SINK} = 6 \text{ mA}$
High Impedance Leakage Current	0.001		0.0	μA typ	
high impedance Leakage current	0.001		±1	μA max	
High Impedance Output Capacitance ¹	4		<u></u>	pF typ	
DYNAMIC CHARACTERISTICS ¹					
t _{on}	75			ns typ	$R_L = 100 \Omega, C_L = 35 pF$
	93	110	120	ns max	$V_s = 10 V$; see Figure 30
t _{off}	25			ns typ	$R_L = 100 \Omega, C_L = 35 pF$
	35	35	35	ns max	$V_s = 10 V$; see Figure 30
Charge Injection	10			pC typ	$V_s = 0 V$, $R_s = 0 \Omega$, $C_L = 1 nF$; see Figure 31
Off Isolation	-73			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 26
Channel-to-Channel Crosstalk	-75			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 27
Total Harmonic Distortion (THD + N)	0.05			% typ	$R_{L} = 110 \Omega$, 15 V p-p, f = 20 Hz to 20 kHz; see Figure 29
–3 dB Bandwidth	256			MHz typ	$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 28
Insertion Loss	0.55			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 28
C_D, C_S (Off)	8			pF typ	f = 1 MHz
C_D, C_S (On)	32			pF typ	f = 1 MHz

Parameter	+25°C	-40°C to +85°C	–40°C to +125°C	Unit	Test Conditions/Comments
POWER REQUIREMENTS					$V_{DD} = +16.5 \text{ V}, V_{SS} = -16.5 \text{ V}$
lod	0.001			μA typ	Digital inputs = $0 V \text{ or } V_L$
			1	μA max	
l∟ Inactive	0.3			μA typ	Digital inputs = $0 V \text{ or } V_L$
			1	μA max	
I∟ Active @ 30 MHz	0.26			mA typ	Digital inputs toggle between 0 V and V $_{L}$
		0.3	0.35	mA max	
I∟ Active @ 50 MHz	0.42			mA typ	Digital inputs toggle between 0 V and $V_{\text{\tiny L}}$
		0.5	0.55	mA max	
I _{SS}	0.001			μA typ	Digital inputs = $0 V \text{ or } V_L$
			1	μA max	
V _{DD} /V _{SS}			±4.5/±16.5	V min/max	

¹ Guaranteed by design, not subject to production test.

12 V SINGLE SUPPLY

 V_{DD} = 12 V \pm 10%, V_{SS} = 0 V, V_{L} = 2.7 V to 5.5 V, GND = 0 V, unless otherwise noted.

Table 2.

		–40°C to	–40°C to		
Parameter	+25°C	+85°C	+125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			0 to V _{DD}	V	
On Resistance (R _{ON})	18			Ωtyp	$V_{DD} = 10.8 V$, $V_{SS} = 0 V$; $V_S = 0 V$ to 10 V, I _S = -10 mA; see Figure 23
	21.5	26	28.5	Ωmax	
On-Resistance Match Between Channels (ΔR _{oN})	0.55			Ωtyp	$V_{DD} = 10.8 V$, $V_{SS} = 0 V$; $V_S = 0 V$ to 10 V, $I_S = -10 mA$
	1.2	1.6	1.8	Ωmax	
On-Resistance Flatness ($R_{FLAT(ON)}$)	5			Ωtyp	$V_{\text{DD}} = 10.8 \text{ V}, V_{\text{SS}} = 0 \text{ V}; V_{\text{S}} = 0 \text{ V to } 10 \text{ V}, \\ I_{\text{S}} = -10 \text{ mA}$
	6	6.9	7.3	Ωmax	
LEAKAGE CURRENTS					$V_{\text{DD}} = 10.8 \text{ V}$
Source Off Leakage, Is (Off)	±0.02			nA typ	$V_s = 1 \text{ V}/10 \text{ V}, V_D = 10 \text{ V}/1 \text{ V};$ see Figure 24
	±0.15	±1	±2	nA max	
Drain Off Leakage, I_D (Off)	±0.02			nA typ	$V_s = 1 V/10 V$, $V_D = 10 V/1 V$; see Figure 24
	±0.15	±1	±2	nA max	
Channel On Leakage, I _D , I _S (On)	±0.05			nA typ	$V_s = V_D = 1 V \text{ or } 10 V$; see Figure 25
	±0.3	±2	±4	nA max	
DIGITAL INPUTS					
Input High Voltage, VINH			2.0	V min	
Input Low Voltage, V _{INL}			0.8	V max	
Input Current	±0.001			μA typ	$V_{IN} = V_{GND} \text{ or } V_L$
			±0.1	μA max	
Digital Input Capacitance, C _{IN}	4			pF typ	
LOGIC OUTPUTS (SDO)					
VoL, Output Low Voltage ¹			0.4	V max	$I_{SINK} = 3 \text{ mA}$
			0.6	V max	$I_{SINK} = 6 \text{ mA}$
High Impedance Leakage Current			±1	μA max	
High Impedance Output Capacitance ¹	4			pF typ	

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Parameter	+25°C	–40°C to +85°C	–40°C to +125°C	Unit	Test Conditions/Comments
DYNAMIC CHARACTERISTICS ¹					
t _{on}	145			ns typ	R _L = 100 Ω, C _L = 35 pF
	185	220	240	ns max	V _s = 8 V; see Figure 30
t _{OFF}	35			ns typ	R _L = 100 Ω, C _L = 35 pF
	45	46	46	ns max	Vs = 8 V; see Figure 30
Charge Injection	8			pC typ	$V_s = 6 V$, $R_s = 0 \Omega$, $C_L = 1 nF$; see Figure 31
Off Isolation	-70			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 26
Channel-to-Channel Crosstalk	-75			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 27
–3 dB Bandwidth	240			MHz typ	$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 28
Insertion Loss	1.15			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 28
C _D , C _S (Off)	12			pF typ	f = 1 MHz
C _D , C _s (On)	33			pF typ	f = 1 MHz
POWER REQUIREMENTS					$V_{DD} = +13.2 V$
I _{DD}	0.001			μA typ	Digital inputs = $0 V \text{ or } V_{L}$
			1	μA max	
I _L Inactive	0.3			μA typ	Digital inputs = $0 V \text{ or } V_L$
			1	μA max	
I_L Active @ 30 MHz	0.26			mA typ	Digital inputs toggle between 0 V and $V_{\mbox{\tiny L}}$
		0.3	0.35	mA max	
I∟ Active @ 50 MHz	0.42			mA typ	Digital inputs toggle between 0V and $V_{\mbox{\tiny L}}$
		0.5	0.55	mA max	
Iss	0.001			μA typ	Digital inputs = $0 V \text{ or } V_{L}$
			1	μA max	
V _{DD} /V _{SS}			±4.5/±16.5	V min/max	

¹ Guaranteed by design, not subject to production test.

±5 V DUAL SUPPLY

 V_{DD} = +5 V \pm 10%, V_{SS} = -5 V \pm 10%, V_{L} = 2.7 V to $V_{\text{DD}},$ GND = 0 V, unless otherwise noted.

Table 3.

Parameter	+25°C	–40°C to +85°C	–40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			V_{SS} to V_{DD}	V	
On Resistance (R _{ON})	21			Ωtyp	V_{DD} = +4.5 V, V_{SS} = -4.5 V, V_S = ±4.5 V, I_S = -10 mA; see Figure 23
	25	29	32	Ωmax	_
On-Resistance Match Between Channels (ΔR _{ON})	0.6			Ωtyp	$V_{DD} = +4.5 \text{ V}, V_{SS} = -4.5 \text{ V}, V_S = \pm 4.5 \text{ V}, I_S = -10 \text{ mA}$
	1.3	1.7	1.9	Ωmax	
On-Resistance Flatness (R _{FLAT(ON)})	5.2			Ωtyp	$V_{DD} = +4.5 V$, $V_{SS} = -4.5 V$, $V_S = \pm 4.5 V$;
	6.4	7.3	7.6	Ωmax	$I_s = -10 \text{ mA}$
LEAKAGE CURRENTS					$V_{DD} = +5.5 V, V_{SS} = -5.5 V$
Source Off Leakage, I₅ (Off)	±0.02			nA typ	$V_s = \pm 4.5 V$, $V_D = \pm 4.5 V$; see Figure 24
3 • • •	±0.15	±1	±2	nA max	
Drain Off Leakage, I _D (Off)	±0.02			nA typ	$V_{s} = \pm 4.5 \text{ V}, V_{D} = \mp 4.5 \text{ V}; \text{ see Figure 24}$
	±0.15	±1	±2	nA max	$v_{s} = \pm 4.5 v, v_{b} = \pm 4.5 v, see Figure 24$
Channel On Leakage, I _D , I _S (On)	±0.15	±1	<u> </u>	nA typ	$V_s = V_D = \pm 4.5 V$; see Figure 25
Channel On Leakage, 10, 15 (Oh)	±0.05	±2	±4	nA max	vs = vb = ±4.5 v, see rigure 25
DIGITAL INPUTS	±0.5	÷Ζ	<u> </u>	Th/Thux	
Input High Voltage, V _{INH}			2.0	V min	
Input Low Voltage, VINH			0.8	V max	
Input Current	±0.001		0.0	μA typ	$V_{IN} = V_{GND}$ or V_{I}
input current	10.001		±0.1	μA max	
Digital Input Capacitance, C _{IN}	4		±0.1	pF typ	
LOGIC OUTPUTS (SDO)	1				
V_{OL} , Output Low Voltage ¹			0.4	V max	I _{SINK} = 3 mA
			0.6	V max	$I_{\text{SINK}} = 6 \text{ mA}$
High Impedance Leakage Current			±1	µA max	
High Impedance Output	4			pF typ	
Capacitance ¹				P. 9P	
DYNAMIC CHARACTERISTICS ¹					
ton	190			ns typ	$R_L = 100 \Omega, C_L = 35 pF$
	250	290	320	ns max	$V_s = 3 V$; see Figure 30
toff	45			ns typ	$R_L = 100 \Omega, C_L = 35 pF$
	60	65	70	ns max	$V_s = 3 V$; see Figure 30
Charge Injection	7			pC typ	$V_s = 0 V$, $R_s = 0 \Omega$, $C_L = 1 nF$; see Figure 31
Off Isolation	-70			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 26
Channel-to-Channel Crosstalk	-75			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 27
Total Harmonic Distortion, THD + N	0.14			% typ	R_L = 110 $\Omega,$ 5 V p-p, f = 20 Hz to 20 kHz; see Figure 29
–3 dB Bandwidth	256			MHz typ	$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 28
Insertion Loss	1			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 28
C _D , C _S (Off)	11			pF typ	f = 1 MHz
C _D , C _s (On)	35			pF typ	f = 1 MHz

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Parameter	+25°C	–40°C to +85°C	–40°C to +125°C	Unit	Test Conditions/Comments
POWER REQUIREMENTS					$V_{DD} = +5.5 V, V_{SS} = -5.5 V$
IDD	0.001			μA typ	Digital inputs = $0 V$ or V_L
			1	μA max	
I∟ Inactive	0.3			μA typ	Digital inputs = $0 V \text{ or } V_{L}$
			1	μA max	
I∟ Active @ 30 MHz	0.26			mA typ	Digital inputs toggle between 0 V and V_L
		0.3	0.35	mA max	
I∟ Active @ 50 MHz	0.42			mA typ	Digital inputs toggle between 0 V and V_L
		0.5	0.55	mA max	
Iss	0.001			μA typ	Digital inputs = $0 V$ or V_L
			1	μA max	
V _{DD} /V _{SS}			±4.5/±16.5	V min/max	

¹ Guaranteed by design, not subject to production test.

CONTINUOUS CURRENT PER CHANNEL

Table 4. Eight Channels On

Parameter	25°C	85°C	125°C	Unit	Test Conditions/Comments
CONTINUOUS CURRENT PER CHANNEL ¹					
15 V Dual Supply					$V_{DD} = +13.5 V$, $V_{SS} = -13.5 V$
24-Lead TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	67	46	31	mA max	
24-Lead LFCSP ($\theta_{JA} = 30.4^{\circ}C/W$)	121	75	42	mA max	
12 V Single Supply					$V_{\text{DD}} = 10.8 \text{ V}, V_{\text{SS}} = 0 \text{ V}$
24-Lead TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	64	44	30	mA max	
24-Lead LFCSP ($\theta_{JA} = 30.4^{\circ}C/W$)	115	72	41	mA max	
5 V Dual Supply					$V_{DD} = +4.5 V, V_{SS} = -4.5 V$
24-Lead TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	48	35	22	mA max	
24-Lead LFCSP ($\theta_{JA} = 30.4^{\circ}C/W$)	86	57	36	mA max	

¹ Guaranteed by design, not subject to production test.

Table 5. One Channel On

Parameter	25°C	85°C	125°C	Unit	Test Conditions/Comments
CONTINUOUS CURRENT PER CHANNEL ¹					
15 V Dual Supply					$V_{DD} = +13.5 V$, $V_{SS} = -13.5 V$
24-Lead TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	169	97	48	mA max	
24-Lead LFCSP ($\theta_{JA} = 30.4^{\circ}C/W$)	295	139	55	mA max	
12 V Single Supply					$V_{DD} = 10.8 V, V_{SS} = 0 V$
24-Lead TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	161	93	47	mA max	
24-Lead LFCSP ($\theta_{JA} = 30.4^{\circ}C/W$)	281	135	54	mA max	
5 V Dual Supply					$V_{DD} = +4.5 V, V_{SS} = -4.5 V$
24-Lead TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	122	76	43	mA max	
24-Lead LFCSP ($\theta_{JA} = 30.4^{\circ}C/W$)	214	114	51	mA max	

¹ Guaranteed by design, not subject to production test.

TIMING CHARACTERISTICS

All input signals are specified with $t_R = t_F = 1 \text{ ns/V}$ (10% to 90% of V_{DD}) and timed from a voltage level of ($V_{IL} + V_{IH}$)/2 (see Figure 2). $V_{DD} = 4.5 \text{ V}$ to 16.5 V; $V_{SS} = -16.5 \text{ V}$ to 0 V; $V_L = 2.7 \text{ V}$ to 5.5 V or V_{DD} (whichever is less); GND = 0 V; all specifications T_{MIN} to T_{MAX} , unless otherwise noted.¹

Table 6.

Parameter	Limit at T _{MIN} , T _{MAX}	Unit	Conditions/Comments
t1 ²	20	ns min	SCLK cycle time
t ₂	9	ns min	SCLK high time
t ₃	9	ns min	SCLK low time
t ₄	5	ns min	SYNC to SCLK active edge setup time
t ₅	5	ns min	Data setup time
t ₆	5	ns min	Data hold time
t7	5	ns min	SCLK active edge to SYNC rising edge
t ₈	15	ns min	Minimum SYNC high time
t9	5	ns min	SYNC rising edge to next SCLK active edge ignored
t ₁₀	5	ns min	SCLK active edge to SYNC falling edge ignored
t ₁₁ ³	40	ns max	SCLK rising edge to SDO valid
t ₁₂	15	ns min	Minimum RESET pulse width

¹ Guaranteed by design and characterization, not production tested.

² Maximum SCLK frequency is 50 MHz at $V_{DD} = 4.5$ V to 16.5 V; $V_{SS} = -16.5$ V to 0 V, $V_L = 2.7$ V to 5.5 V or V_{DD} (whichever is less); GND = 0 V.

 3 Measured with the 1 k Ω pull-up resistor to V_L and 20 pF load. t₁₁ determines the maximum SCLK frequency in daisy-chain mode.

Timing Diagrams







ABSOLUTE MAXIMUM RATINGS

 $T_A = 25^{\circ}C$, unless otherwise noted.

Table 7.

1 4010 / 1	
Parameter	Rating
V _{DD} to V _{SS}	35 V
V _{DD} to GND	–0.3 V to +25 V
Vss to GND	+0.3 V to -25 V
V_L to GND	–0.3 V to +7 V
Analog Inputs ¹	V _{SS} – 0.3 V to V _{DD} + 0.3 V or 30 mA, whichever occurs first
Digital Inputs ¹	GND – 0.3 V to V_L + 0.3 V or 30 mA, whichever occurs first
Continuous Current, Sx or Dx Pins	Table 4 specifications + 15%
Peak Current, Sx or Dx (Pulsed at 1 ms, 10% Duty Cycle Max)	
TSSOP Package	300 mA
LFCSP Package	400 mA
Operating Temperature Range	
Industrial (B Version)	-40°C to +125°C
Storage Temperature Range	–65°C to +150°C
Junction Temperature	150°C
Reflow Soldering Peak	260°C
Temperature, Pb free	
Time at Peak Temperature	10 sec to 40 sec

¹ Overvoltages at the analog and digital inputs are clamped by internal diodes. Limit the current to the maximum ratings given.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Only one absolute maximum rating may be applied at any one time.

THERMAL RESISTANCE

Table 8. Thermal Resistance

Package Type	θ」Α	θıc	Unit
24-Lead TSSOP ¹	112.6	50	°C/W
24-Lead LFCSP ²	30.4		°C/W

¹ 4-layer board.

² 4-layer board and exposed paddle soldered to V_{ss}.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

Figure 5. LFCSP Pin Configuration

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS



Figure 4. TSSOP Pin Configuration

Table 9. Pin Function Descriptions

Pin No.						
TSSOP	TSSOP LFCSP		Description			
1	22	SCLK	Serial Clock Input. Data is clocked into the input shift register on the falling edge of the serial clock input. Data can be transferred at rates of up to 50 MHz.			
2	23	V _{DD}	Most Positive Power Supply Potential.			
3	24	DIN	Serial Data Input. This device has an 8-bit shift register. Data is clocked into the register on the falling edge of the serial clock input.			
4	1	GND	Ground (0 V) Reference.			
5	2	S1	Source Terminal 1. This pin can be an input or an output.			
6	3	D1	Drain Terminal 1. This pin can be an input or an output.			
7	4	S2	Source Terminal 2. This pin can be an input or an output.			
8	5	D2	Drain Terminal 2. This pin can be an input or an output.			
9	6	S3	Source Terminal 3. This pin can be an input or an output.			
10	7	D3	Drain Terminal 3. This pin can be an input or an output.			
11	8	S4	Source Terminal 4. This pin can be an input or an output.			
12	9	D4	Drain Terminal 4. This pin can be an input or an output.			
13	10	D5	Drain Terminal 5. This pin can be an input or an output.			
14	11	S5	Source Terminal 5. This pin can be an input or an output.			
15	12	D6	Drain Terminal 6. This pin can be an input or an output.			
16	13	S6	Source Terminal 6. This pin can be an input or an output.			
17	14	D7	Drain Terminal 7. This pin can be an input or an output.			
18	15	S7	Source Terminal 7. This pin can be an input or an output.			
19	16	D8	Drain Terminal 8. This pin can be an input or an output.			
20	17	S8	Source Terminal 8. This pin can be an input or an output.			
21	18	V _{ss}	Most Negative Power Supply Potential. In single-supply applications, it can be connected to ground.			
22	19	SDO	Serial Data Output. This pin can be used for daisy-chaining a number of these devices together or for reading back the data in the shift register for diagnostic purposes. The serial data is transferred on the rising edge of SCLK and is valid on the falling edge of the clock. Pull this open-drain output to the supply with an external resistor.			
23	20	RESET/VL	RESET/Logic Power Supply Input (V _L). Under normal operation, drive the RESET/V _L pin with a 2.7 V to 5 V supply. Pull the pin low (<0.8 V) for a short period of time (15 ns is sufficient) to complete a hardware reset. All switches are opened, and the appropriate registers are cleared to 0. When using the RESET/V _L pin to complete a hardware reset, all other SPI pins (SYNC, SCLK, and DIN) should be driven low.			

Pin No.					
TSSOP	LFCSP	Mnemonic	Description		
24	21	SYNC	Active Low Control Input. This is the frame synchronization signal for the input data. When SYNC goes low, it powers on the SCLK and DIN buffers and enables the input shift register. Data is transferred in on the falling edges of the following clocks. Taking SYNC high updates the switch condition.		
N/A^1	EP	Exposed Pad	Exposed Pad. Exposed pad tied to the substrate, Vss.		

 $^{\rm 1}$ N/A means not applicable.

TYPICAL PERFORMANCE CHARACTERISTICS



Figure 6. On Resistance as a Function of V_D (V_s), Dual Supply



Figure 7. On Resistance as a Function of V_D (Vs), Dual Supply



Figure 8. On Resistance as a Function of V_D (V_S), Single Supply



Figure 9. On Resistance as a Function of V_D (V_s), for Different Temperatures, 15 V Dual Supply



Figure 10. On Resistance as a Function of V_D (V_S), for Different Temperatures, 5 V Dual Supply



Figure 11. On Resistance as a Function of V_D (V_S), for Different Temperatures, 12 V Single Supply



Figure 12. Leakage Current as a Function of Temperature, 15 V Dual Supply



Figure 14. Leakage Current as a Function of Temperature, 12 V Single Supply











TEST CIRCUITS





TERMINOLOGY

IDD

The positive supply current.

Iss

The negative supply current.

V_D (Vs)

The analog voltage on Terminal Dx or Terminal Sx.

Ron

The ohmic resistance between Terminal Dx and Terminal Sx.

ΔR_{ON}

The difference between the $R_{\rm ON}$ of any two channels.

R_{FLAT(ON)}

Flatness is defined as the difference between the maximum and minimum value of on resistance, as measured over the specified analog signal range.

Is (Off)

The source leakage current with the switch off.

I_D (Off) The drain leakage current with the switch off.

I_D, I_S (On) The channel leakage current with the switch on.

V_{INL} The maximum input voltage for Logic 0.

V_{INH} The minimum input voltage for Logic 1.

I_{INL} (I_{INH}) The input current of the digital input.

C_s (Off)

The off switch source capacitance, measured with reference to ground.

C_D (Off)

The off switch drain capacitance, measured with reference to ground.

$C_D, C_S(On)$

The on switch capacitance, measured with reference to ground.

CIN

The digital input capacitance.

ton

The delay between applying the digital control input and the output switching on. See Figure 30.

toff

The delay between applying the digital control input and the output switching off. See Figure 30.

Charge Injection

A measure of the glitch impulse transferred from the digital input to the analog output during switching.

Off Isolation

A measure of unwanted signal coupling through an off switch.

Crosstalk

A measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.

Bandwidth

The frequency at which the output is attenuated by 3 dB.

On Response

The frequency response of the on switch.

Insertion Loss The loss due to the on resistance of the switch.

THD + N

The ratio of the harmonic amplitude plus noise of the signal to the fundamental.

AC Power Supply Rejection Ratio (ACPSRR)

A measure of the ability of a part to avoid coupling noise and spurious signals that appear on the supply voltage pin to the output of the switch. The dc voltage on the device is modulated by a sine wave of 0.62 V p-p. The ratio of the amplitude of signal on the output to the amplitude of the modulation is the ACPSRR.

THEORY OF OPERATION

The ADG1414 is a set of serially controlled, octal SPST switches. Each of the eight bits of the 8-bit write corresponds to one switch of the device. A Logic 1 in the particular bit position turns the switch on, whereas a Logic 0 turns the switch off. Because each switch is independently controlled by an individual bit, this provides the option of having any, all, or none of the switches turned on.

SERIAL INTERFACE

The ADG1414 has a 3-wire serial interface (SYNC, SCLK, and DIN pins) that is compatible with SPI, QSPI, and MICROWIRE interface standards, as well as most DSPs. See Figure 2 for a timing diagram of a typical write sequence.

The write sequence begins by bringing the SYNC line low. This enables the input shift register. Data from the DIN line is clocked into the 8-bit input shift register on the falling edge of SCLK. The serial clock frequency can be as high as 50 MHz, making the ADG1414 compatible with high speed DSPs.

Data can be written to the shift register in more or less than eight bits. In each case, the shift register retains the last eight bits that were written. When all eight bits have been written into the shift register, the SYNC line is brought high again. The switches are updated with the new configuration, and the input shift register is disabled. With SYNC held high, the input shift register is disabled; therefore, further data or noise on the DIN line has no effect on the shift register.

Data appears on the SDO pin on the rising edge of SCLK suitable for daisy chaining or readback, delayed by eight bits.

INPUT SHIFT REGISTER

The input shift register is eight bits wide (see Table 10). Each bit controls one switch. These data bits are transferred to the switch register on the rising edge of SYNC.

Table 10. ADG1414 Input Shif	ft Register Bit Map ¹
MCD	1

MSB							LSB
DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
S8	S7	S6	S5	S4	S3	S2	S1

¹ Logic 0 = switch off and Logic 1 = switch on.

POWER-ON RESET

The ADG1414 contains a power-on reset circuit. On power-up of the device, all switches are in the off condition and the internal shift register is filled with zeros and remains so until a valid write takes place.

The part also has a $\overline{\text{RESET}}/V_L$ pin. Under normal operation, drive the $\overline{\text{RESET}}/V_L$ pin with a 2.7 V to 5 V supply and pull the pin low for short period of time (15 ns is sufficient) to complete the hardware reset.

When using the $\overline{\text{RESET}}/V_L$ pin to do a hardware reset, drive all other SPI pins ($\overline{\text{SYNC}}$, SCLK, and DIN) low. This is to prevent current flow due to ESD protection diodes on the V_L pin to the SPI pins.

When the $\overline{\text{RESET}}/V_L$ pin is low, all switches are off and the appropriate registers are cleared to 0.

DAISY CHAINING

For systems that contain several switches, the SDO pin can be used to daisy-chain several devices together. The SDO pin can also be used for diagnostic purposes and provide serial readback, wherein the user can read back the switch contents.

SDO is an open-drain output that should be pulled to the $V_{\rm L}$ supply with an external resistor.

The SCLK is continuously applied to the input shift register when SYNC is low. If more than eight clock pulses are applied, the data ripples out of the shift register and appears on the SDO line. This data is clocked out on the rising edge of SCLK and is valid on the falling edge. By connecting this line to the DIN input on the next device in the chain, a multiswitch interface is constructed. Each device in the system requires eight clock pulses; therefore, the total number of clock cycles must equal 8N, where N is the total number of devices in the chain.

When the serial transfer to all devices is complete, SYNC is taken high. This prevents any further data from being clocked into the input shift register.

The serial clock can be a continuous or a gated clock. A continuous SCLK source can be used only if SYNC can be held low for the correct number of clock cycles. In gated clock mode, a burst clock containing the exact number of clock cycles must be used, and SYNC must be taken high after the final clock to latch the data. Gated clock mode reduces power consumption by reducing the active clock time.

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-153-AD Figure 32. 24-Lead Thin Shrink Small Outline Package [TSSOP] (RU-24) Dimensions shown in millimeters



ORDERING GUIDE

Model ¹	Temperature Range	Package Description	Package Option
ADG1414BRUZ	-40°C to +125°C	24-Lead Thin Shrink Small Outline Package [TSSOP]	RU-24
ADG1414BRUZ-REEL7	-40°C to +125°C	24-Lead Thin Shrink Small Outline Package [TSSOP]	RU-24
ADG1414BCPZ-REEL7	-40°C to +125°C	24-Lead Lead Frame Chip Scale Package [LFCSP_VQ]	CP-24-3

 1 Z = RoHS Compliant Part.

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